



Client Name

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Client P/N

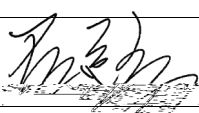

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Product P/N

HL-C3535F9V395-D1-LVR9(Au120)

Sending Date

\_\_\_\_\_

Client approval		Hongli approval		
Approval	Audit	Approval	Audit	Confirmation
				
Qualified	Disqualified	DATE: 2016.05.16		

Adr NO.1,Xi anke Yi Road,Huadong Town,, Huadu Di stri ct, Guangzhou, Chi na

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Tel / 020-86733333 Fax/ 020-86733883 86733938 86733265

Web/ www.hongli tronic.com

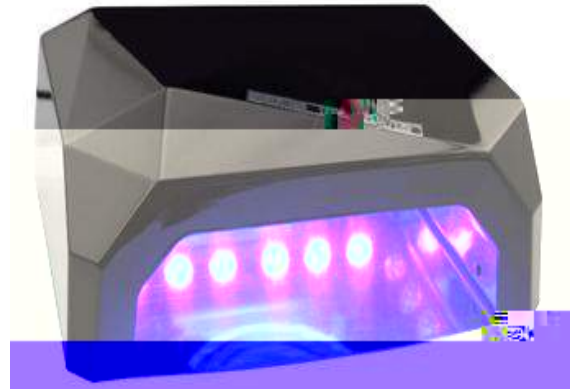
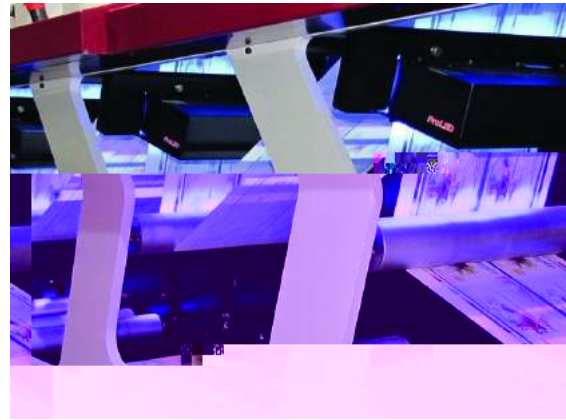
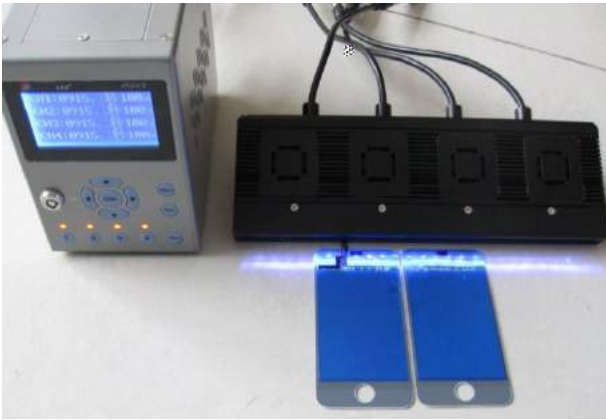
- 1.
- 2.
- 3.
- 4.

## Catalog

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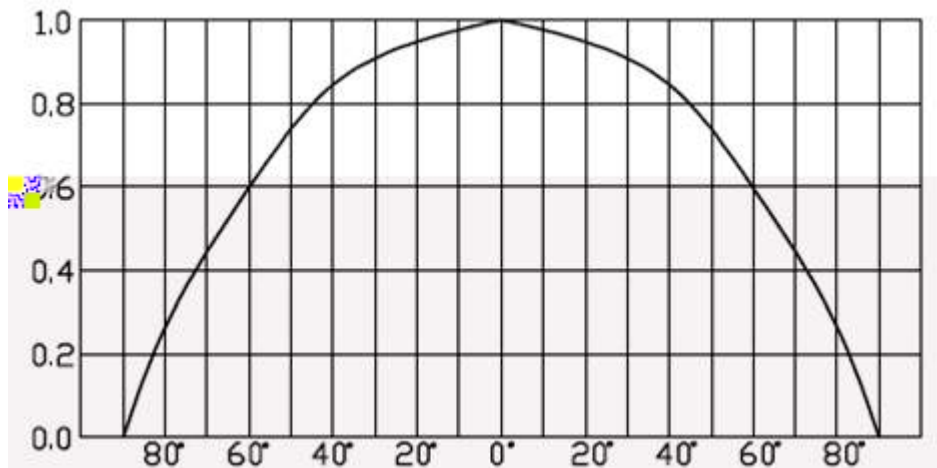
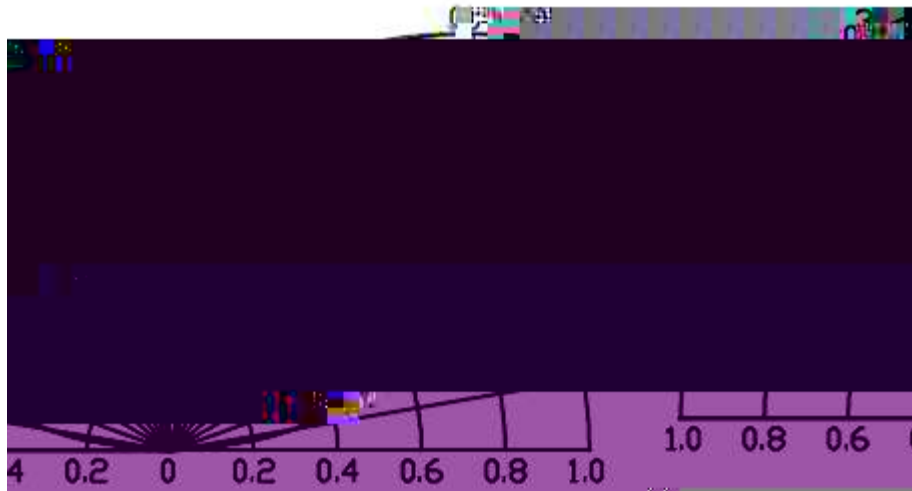


## Application range



Security, Banknote

## Radiation Pattern



### Typical Optical/Electrical Characteristics @Ta=25±7 °HmdY

Symbol	Item	Min.	Typ.	Max.	Units	
e	Radiation Flux辐射功率	700	800	—	mW	IF=500mA
VF	Forward Voltage 正向电压	3.0	—	3.8	V	IF=500mA
λ <sub>p</sub>	Peak Wavelength	390	—	400	nm	IF=500mA
2θ <sub>1/2</sub>	50% Power Angle	—	120	—	deg	IF=500mA
IR	Reverse Current	—	—	50	uA	VR = 5V
L50	Life Time	5000	—	—	Hour	IF=500mA
L50	Life Time	—	3000	—	Hour	IF=700mA

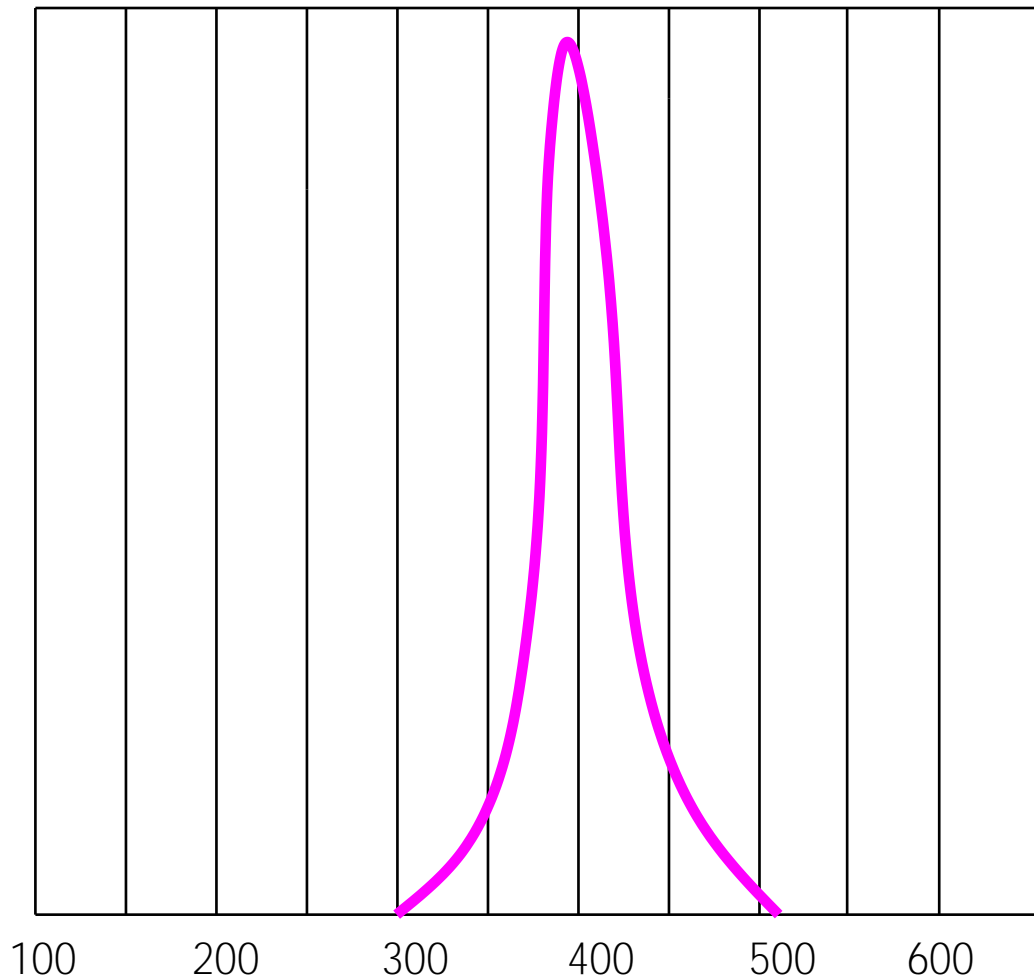
### Absolute Maximum Ratings 绝对最大额定值@H51&)±7

Item名称	Symbol 符号	Absolute Maximum Rating 绝对最大额定值	
Power dissipation	Pd	2.8	W
Peak Forward Current	I <sub>FP</sub>	700	mA
Reverse Voltage	V <sub>R</sub>	5	V

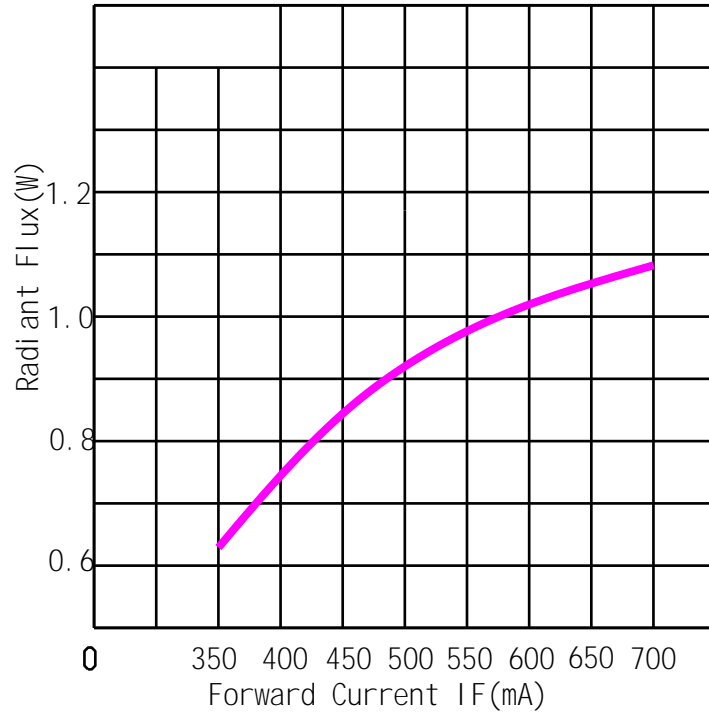
## Typical Optical/Electrical Characteristics Curves ( $T_a=25$ Unless Otherwise Noted )

典型光学/电性特征曲线 ( $T_a=25^{\circ}\text{C}$  除非另有注释)

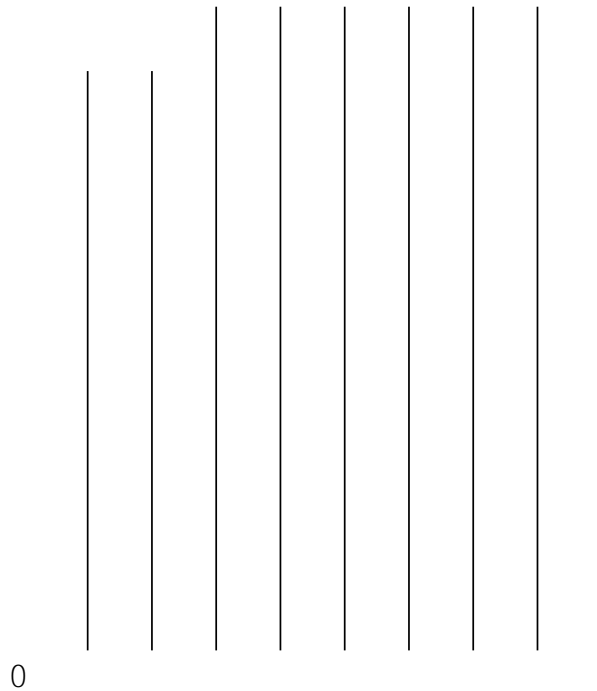
### (1) Wavelength Characteristics



## (2) Relative Radiation Flux-IF

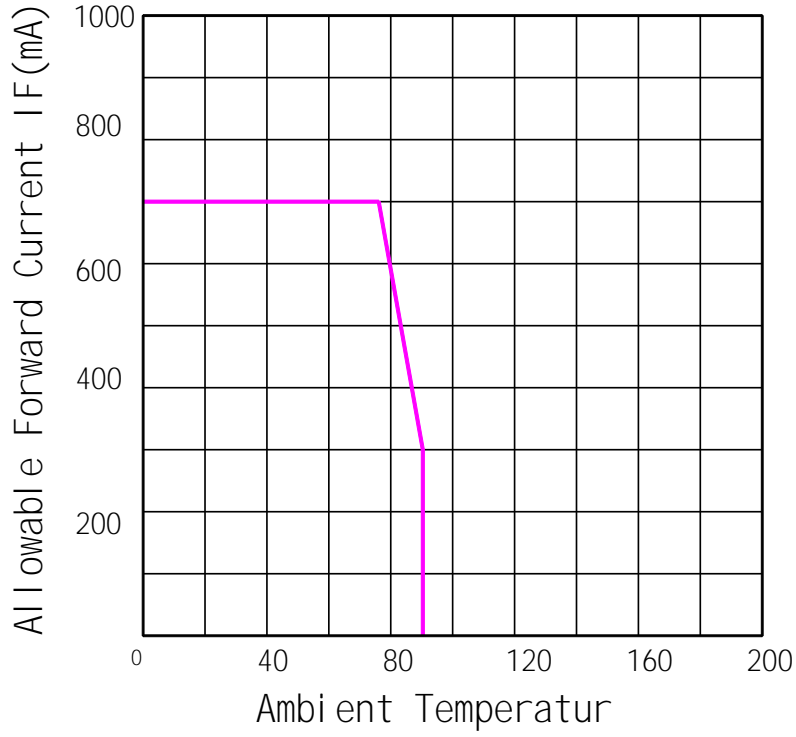


## (3) Relative IF-VF

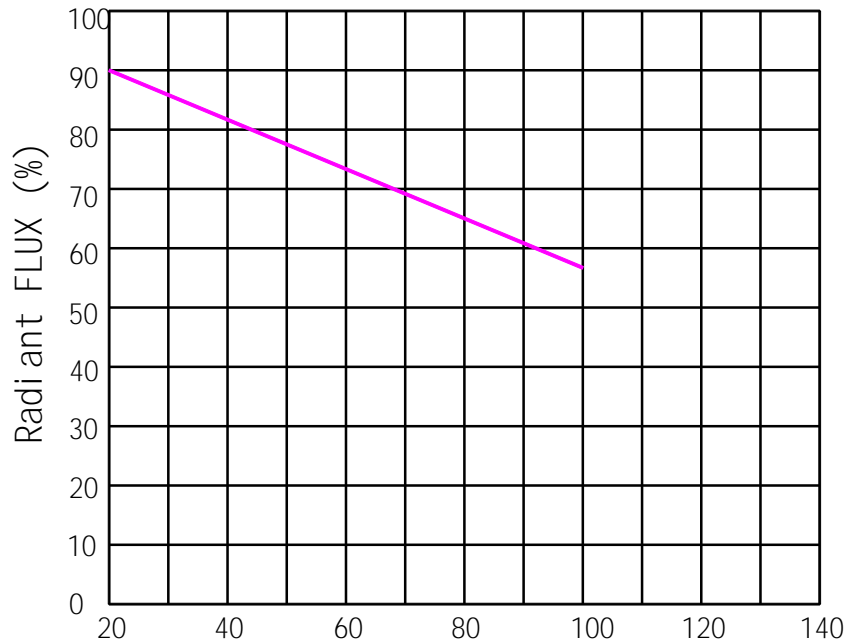




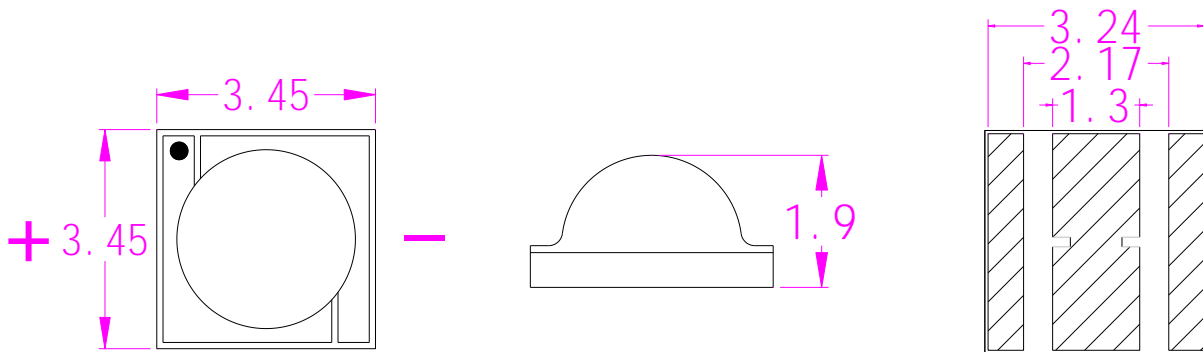
### (4) Allowable Forward Current-Ta



### (5) Radiation Flux-Ta



## Package Dimensions

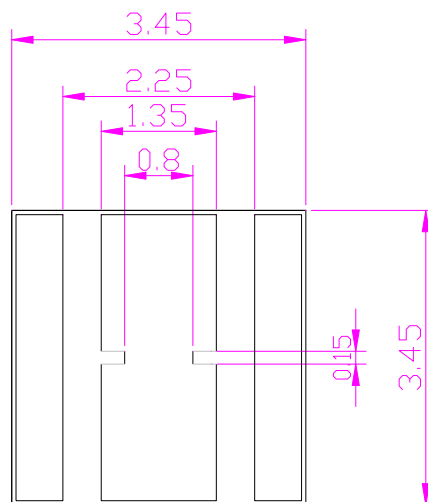


### Notes :

1. All dimension units are millimeters.

$\pm 0.1$

## Welded plate Dimensions



### Notes :

When the circuit configuration is not affected, suggested the increase in the middle of the copper area, or the connection between the middle and the pad and the negative electrode can improve the cooling performance of the product. It is recommended to use 1 mm thickness of steel mask.

1mm

## Label

TYPE: XXXXXXXXXX

QTY: XXXXX

VF: Forward voltage rank

e: Radiation Flux rank

IF: XXXX

$\lambda_p$ : Peak Wavelength

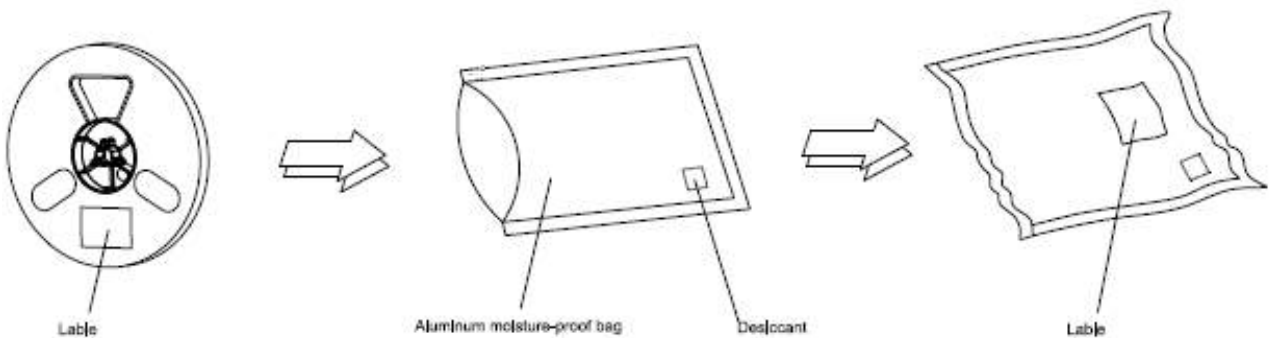
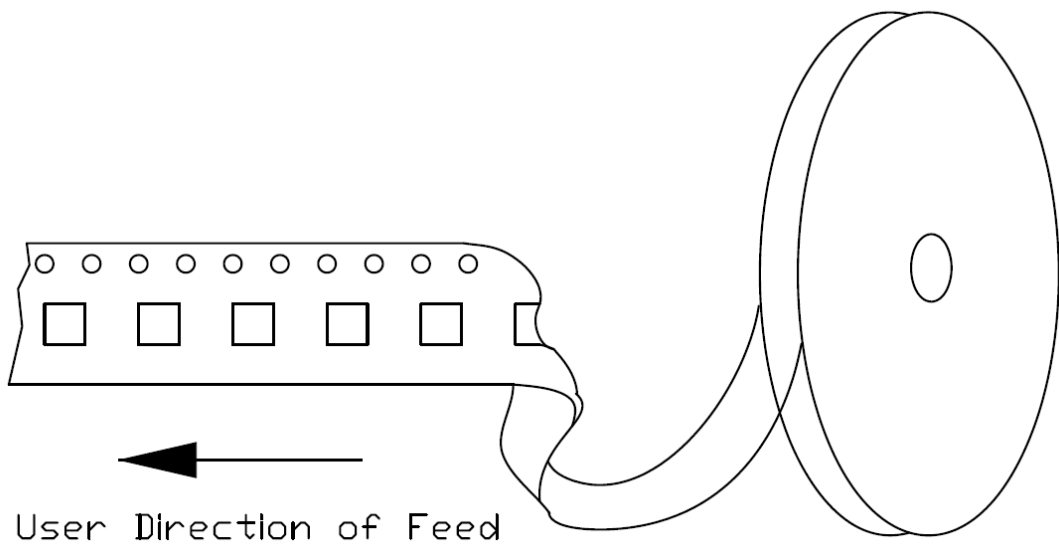
DATE: XXXX

LOT.NO:Lot Number

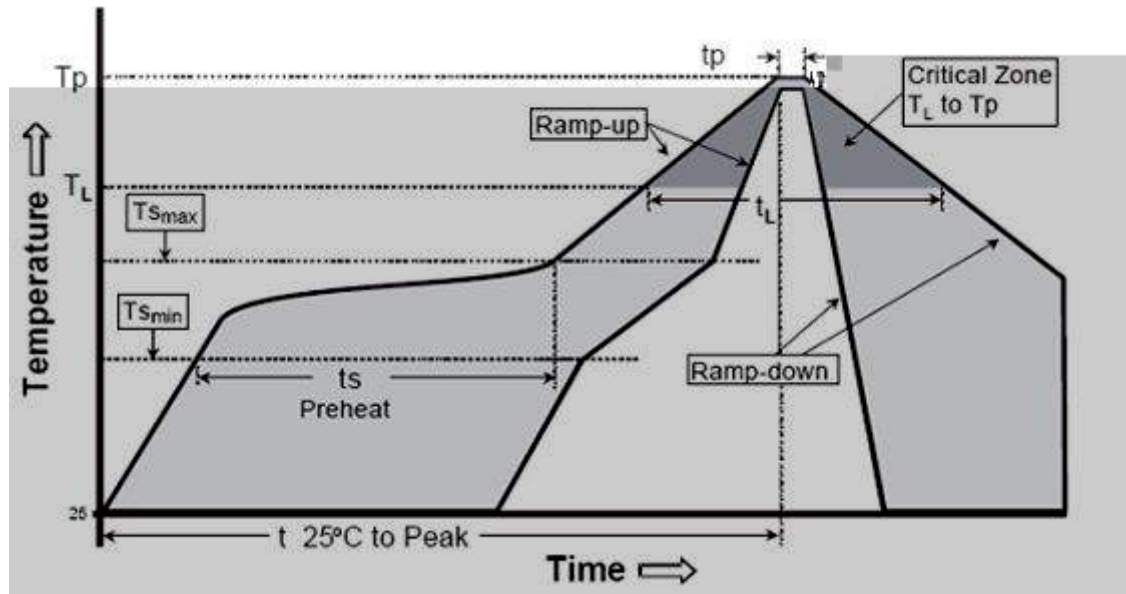
	HONGLITRONIC 鸿利光电	RoHS
TYPE:		QTY:
VF:		:
IF:		:
DATE		LOT. NO:

## Tape Specifications(Units:mm)

(                      (                      )                      **1000 pcs/**



## Reflow soldering instructions



Profile Feature	Lead-Based solder	Lead-Free Solder
Average Ramp-Rate ( $T_{smax}$ to $T_p$ )	3 /second max	3 /second max
Preheat: Temperature Min ( $T_{smin}$ )	100	150
Preheat:Temperature Max ( $T_{smax}$ )	150	200
Preheat:Time( $t_{smin}$ to $t_{smax}$ )	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature( $T_L$ )	183	217
Time Maintained Above: Time( $t_L$ )	60-150 seconds	60-150 seconds
Peak/Classification Temperature( $T_p$ )	215	260
Time Within 5 of Actual Peak Temperature( $t_p$ )	10-15 seconds	20-40 seconds
Ramp-Down Rate	6 /second max	6 /second max
Time 25 to Peak Temperature	6 minutes max	8 minutes max

Note:

1.recommend to use a convection type reflow machine with 8 zones.

2.recommend to use Lead-Free Paste with a melting point between

3.the reflow soldering time should not be more than 360s.all temperature means the temperature measured on the surface of the package body.

360s

4.When using hot plate, the temperature is no more than 260 , the time is not more than 5 seconds.

260

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## Use the matters needing attention(使用注意事项 )

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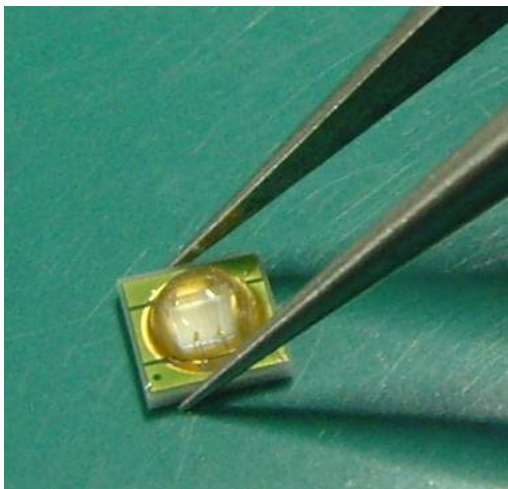
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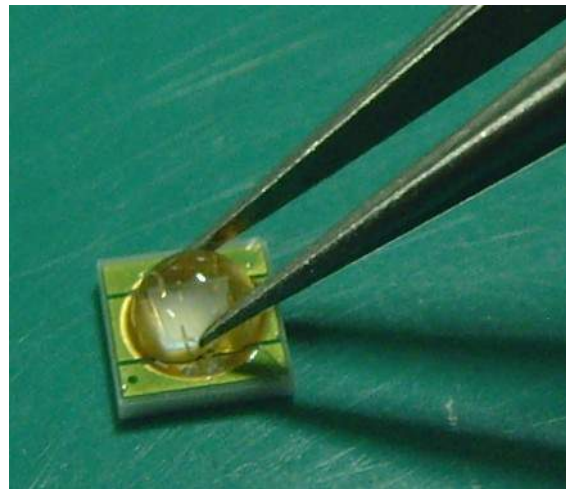
Drive this product at constant current. Output current range specifications should be according to the operational and other conditions, as mentioned in data sheet. Before using a constant voltage source or altered specifications, other than recommended, please consider risk factors.

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OK



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**Notes注**

1.\* All high power emitter LED products mounted on aluminum metal-core printed circuit board, can be lighted directly, but we do not recommend lighting the high power products for more than 5 seconds without a appropriate heat dissipation equipment.

LED

LED 5

2.Reflow soldering should not be done more than two times.The reflow temperature we recommend is 260°C,When the temperature exceeds 260 , the product failure of LED can be caused

260

260

LED